

### General Description

This planar stripe MOSFET has better characteristics, such as fast switching time, low on resistance, low gate charge and excellent avalanche characteristics. It is mainly suitable for electronic ballast and switching mode power supplies.

### FEATURES

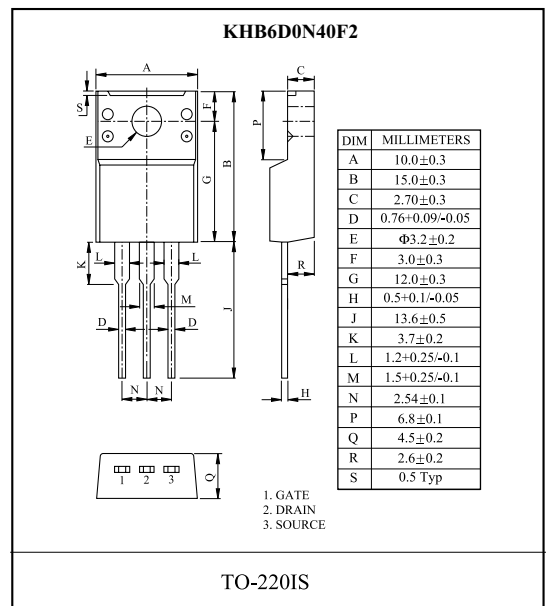
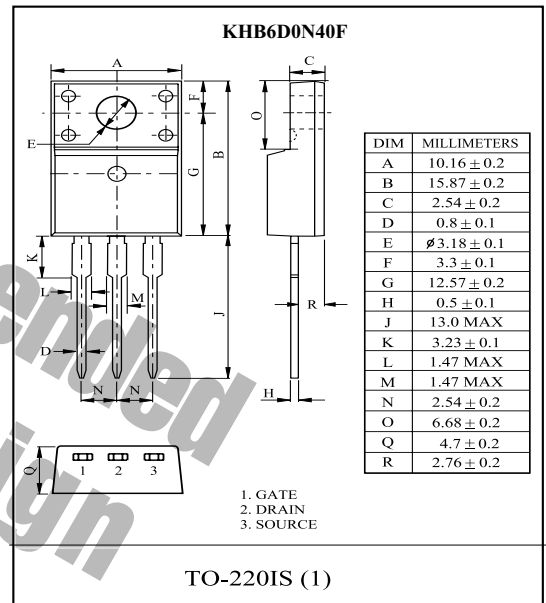
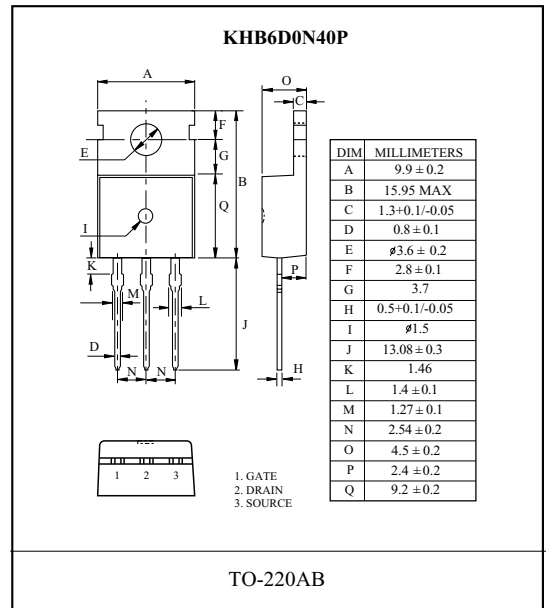
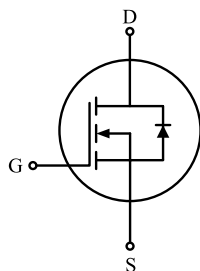
- $V_{DSS}=400V$ ,  $I_D=6.0A$
- Drain-Source ON Resistance :  
 $R_{DS(ON)}=1.0$  @  $V_{GS}=10V$
- $Qg(\text{typ.})=21nC$

### MAXIMUM RATING (Tc=25 )

CHARACTERISTIC	SYMBOL	RATING		UNIT	
		KHB6D0N40P	KHB6D0N40F KHB6D0N40F2		
Drain-Source Voltage	$V_{DSS}$	400		V	
Gate-Source Voltage	$V_{GSS}$	$\pm 30$		V	
Drain Current	@T <sub>c</sub> =25	6.0	6.0*	A	
	@T <sub>c</sub> =100	3.6	3.6*		
	Pulsed (Note1)	I <sub>DP</sub>	24		24*
Single Pulsed Avalanche Energy (Note 2)	E <sub>AS</sub>	320		mJ	
Repetitive Avalanche Energy (Note 1)	E <sub>AR</sub>	7.4		mJ	
Peak Diode Recovery dv/dt (Note 3)	dv/dt	4.5		V/ns	
Drain Power Dissipation	T <sub>c</sub> =25	P <sub>D</sub>	73	38	W
	Derate above 25		0.59	0.3	W/
Maximum Junction Temperature	T <sub>j</sub>	150			
Storage Temperature Range	T <sub>stg</sub>	-55 150			
<b>Thermal Characteristics</b>					
Thermal Resistance, Junction-to-Case	R <sub>thJC</sub>	1.71	3.31	/W	
Thermal Resistance, Case-to-Sink	R <sub>thCS</sub>	0.5	-	/W	
Thermal Resistance, Junction-to-Ambient	R <sub>thJA</sub>	62.5	62.5	/W	

\* : Drain current limited by maximum junction temperature.

### PIN CONNECTION



# KHB6D0N40P/F/F2

## ELECTRICAL CHARACTERISTICS (Tc=25 )

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
<b>Static</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$I_D=250\ \mu A, V_{GS}=0V$	400	-	-	V
Breakdown Voltage Temperature Coefficient	$BV_{DSS}/T_j$	$I_D=250\ \mu A$ , Referenced to 25	-	0.54	-	V/
Drain Cut-off Current	$I_{DSS}$	$V_{DS}=400V, V_{GS}=0V$ ,	-	-	10	$\mu A$
Gate Threshold Voltage	$V_{th}$	$V_{DS}=V_{GS}, I_D=250\ \mu A$	2.0	-	4.0	V
Gate Leakage Current	$I_{GSS}$	$V_{GS}=\pm 30V, V_{DS}=0V$	-	-	$\pm 100$	nA
Drain-Source ON Resistance	$R_{DS(ON)}$	$V_{GS}=10V, I_D=3A$	-	0.9	1	
<b>Dynamic</b>						
Total Gate Charge	$Q_g$	$V_{DS}=320V, I_D=6A$ $V_{GS}=10V$ (Note4,5)	-	21	25	nC
Gate-Source Charge	$Q_{gs}$		-	3.6	4.4	
Gate-Drain Charge	$Q_{gd}$		-	8.3	13	
Turn-on Delay time	$t_{d(on)}$	$V_{DD}=200V$ $R_L=33$ $R_G=25$ (Note4,5)	-	-	40	ns
Turn-on Rise time	$t_r$		-	-	50	
Turn-off Delay time	$t_{d(off)}$		-	-	200	
Turn-off Fall time	$t_f$		-	-	70	
Input Capacitance	$C_{iss}$	$V_{DS}=25V, V_{GS}=0V, f=1.0MHz$	-	822	1020	pF
Reverse Transfer Capacitance	$C_{rss}$		-	14	17	
Output Capacitance	$C_{oss}$		-	97	120	
<b>Source-Drain Diode Ratings</b>						
Continuous Source Current	$I_S$	$V_{GS}<V_{th}$	-	-	6	A
Pulsed Source Current	$I_{SP}$		-	-	24	
Diode Forward Voltage	$V_{SD}$	$I_S=6A, V_{GS}=0V$	-	-	1.5	V
Reverse Recovery Time	$t_{rr}$	$I_S=6A, V_{GS}=0V$ ,	-	270	-	ns
Reverse Recovery Charge	$Q_{rr}$	$dI_S/dt=100A/\mu s$	-	2.15	-	$\mu C$

Note 1) Repetivity rating : Pulse width limited by junction temperature.

Note 2)  $L=20.1mH, I_S=6A, V_{DD}=50V, R_G=25$  , Starting  $T_j=25$  .

Note 3)  $I_S=6A, dI/dt=100A/\mu s, V_{DD}=BV_{DSS}$ , Starting  $T_j=25$  .

Note 4) Pulse Test : Pulse width  $300\mu s$ , Duty Cycle 2%.

Note 5) Essentially independent of operating temperature.

# KHB6D0N40P/F/F2

Fig1.  $I_D - V_{DS}$

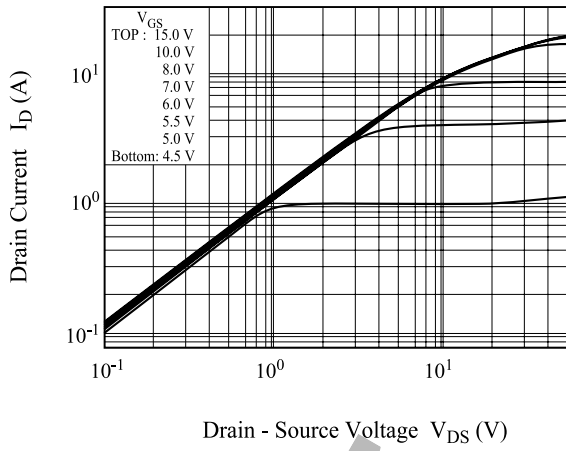


Fig2.  $I_D - V_{GS}$

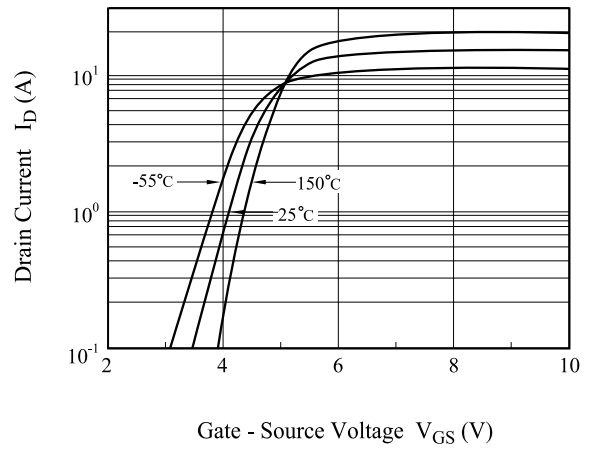


Fig3.  $BV_{DSS} - T_j$

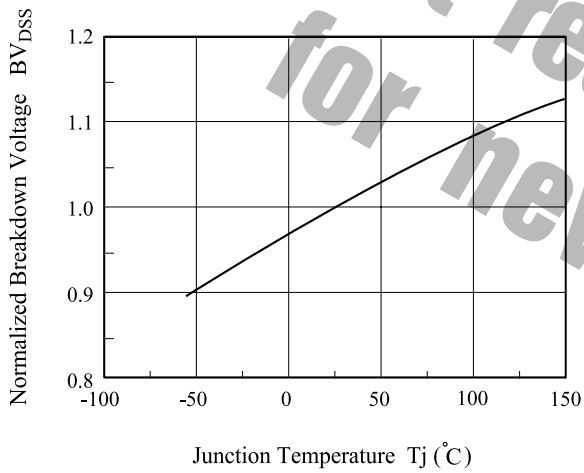


Fig4.  $R_{DS(ON)} - I_D$

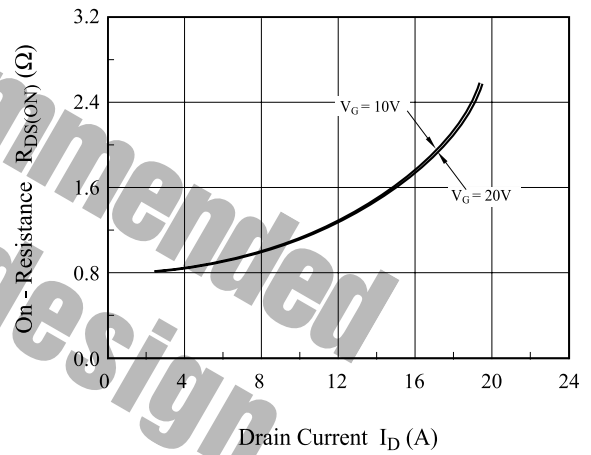


Fig5.  $I_{DR} - V_{SD}$

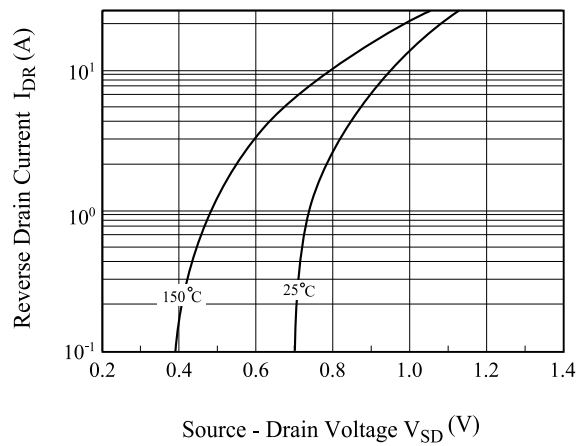
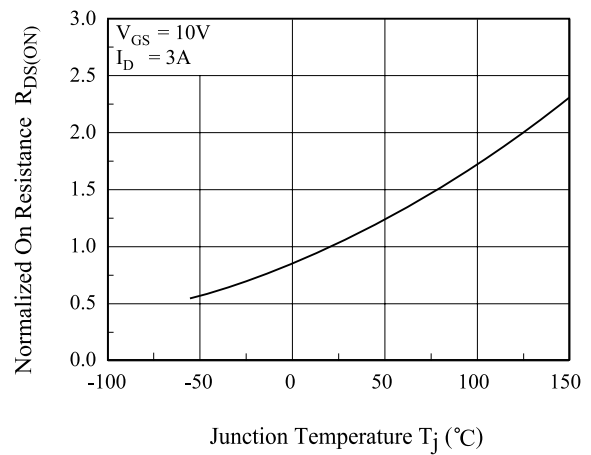


Fig6.  $R_{DS(ON)} - T_j$



# KHB6D0N40P/F/F2

Fig7. C - V<sub>DS</sub>

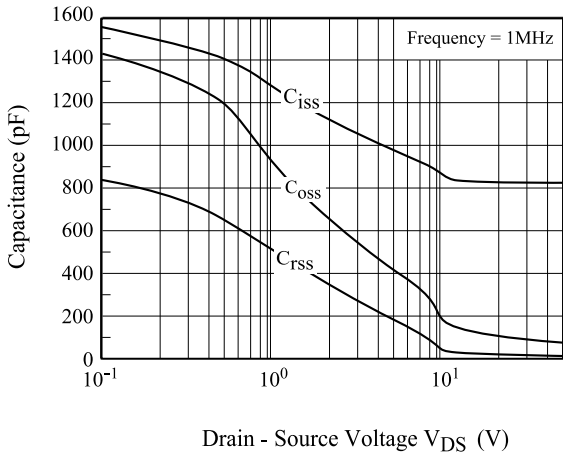


Fig8. Q<sub>g</sub>- V<sub>GS</sub>

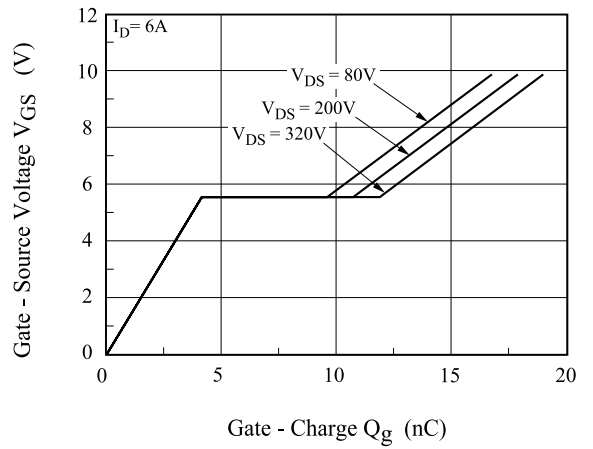


Fig9. Safe Operation Area

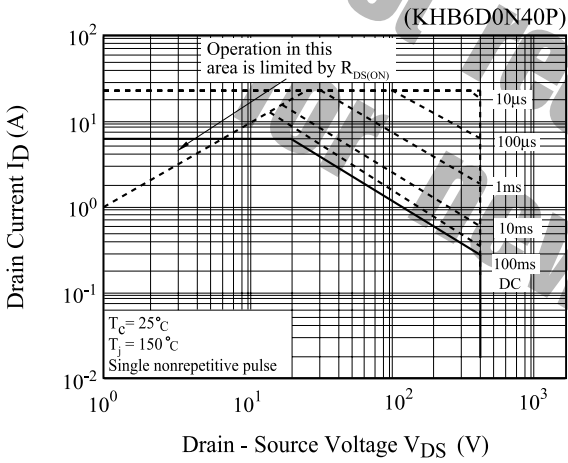


Fig10. Safe Operation Area

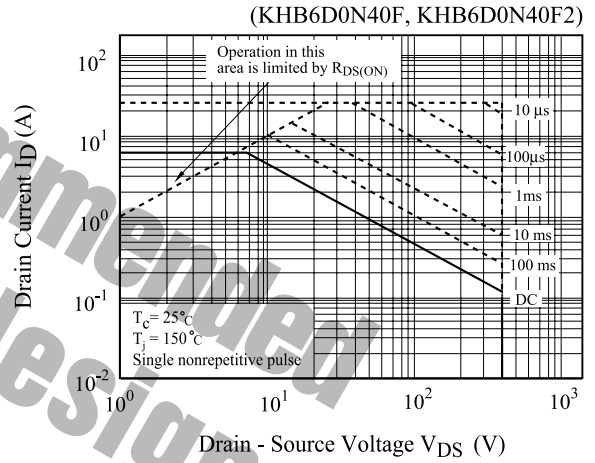
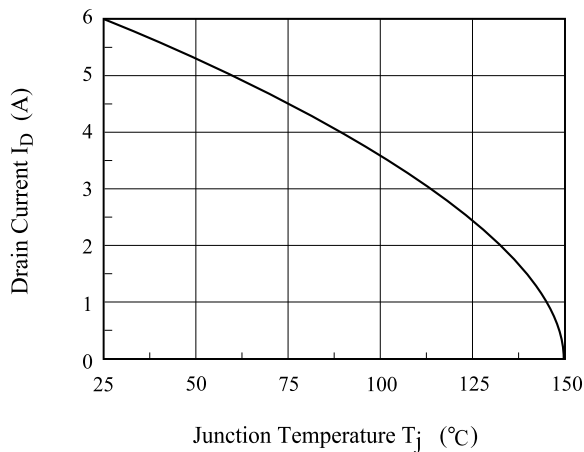


Fig11. I<sub>D</sub> - T<sub>j</sub>



# KHB6D0N40P/F/F2

Fig12. Transient Thermal Response Curve

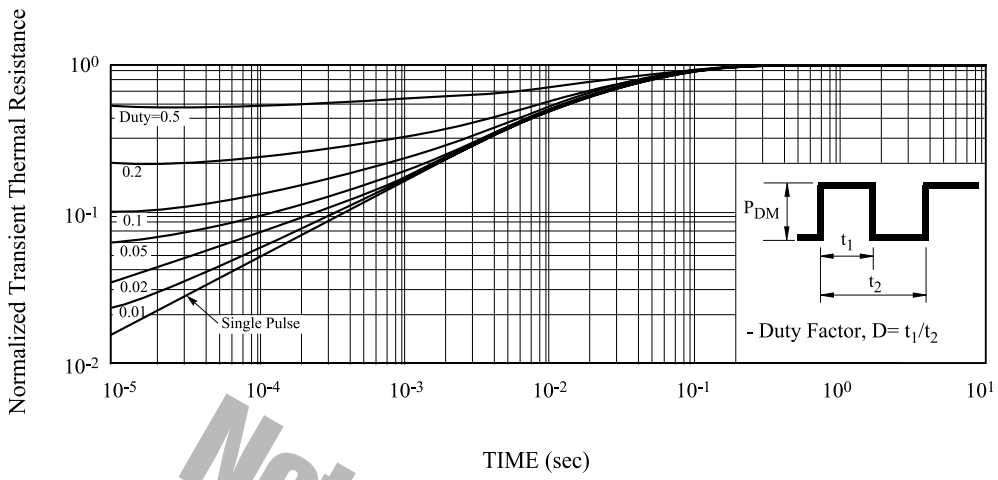
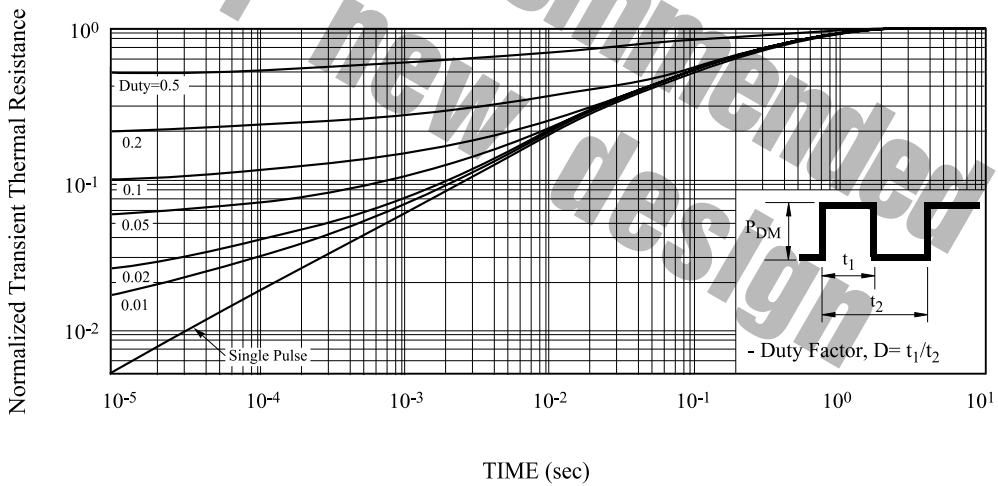


Fig13. Transient Thermal Response Curve



# KHB6D0N40P/F/F2

Fig14. Gate Charge

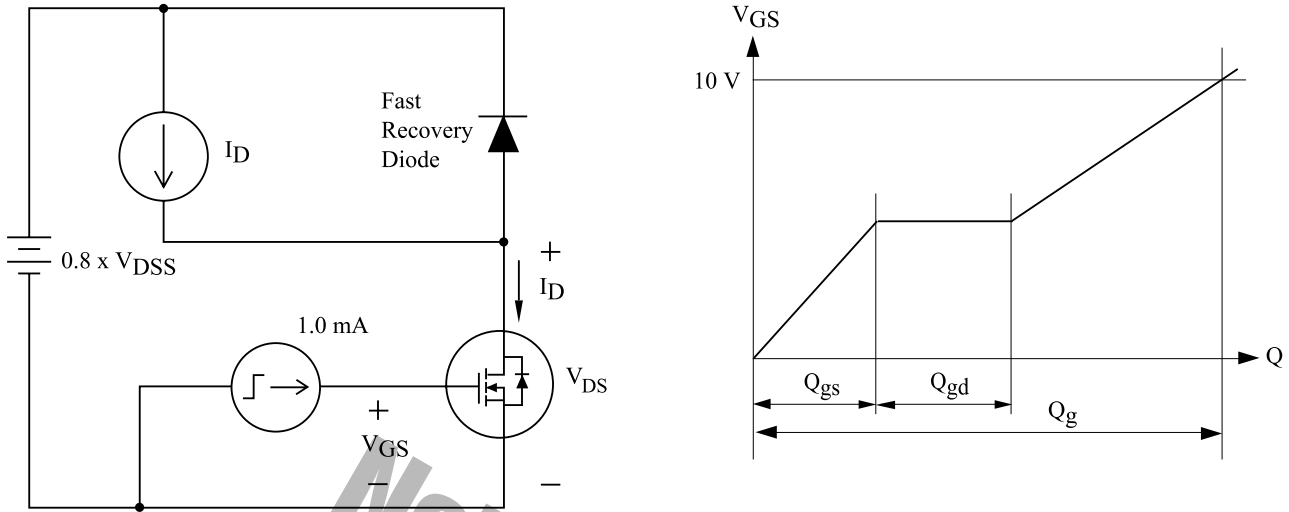


Fig15. Single Pulsed Avalanche Energy

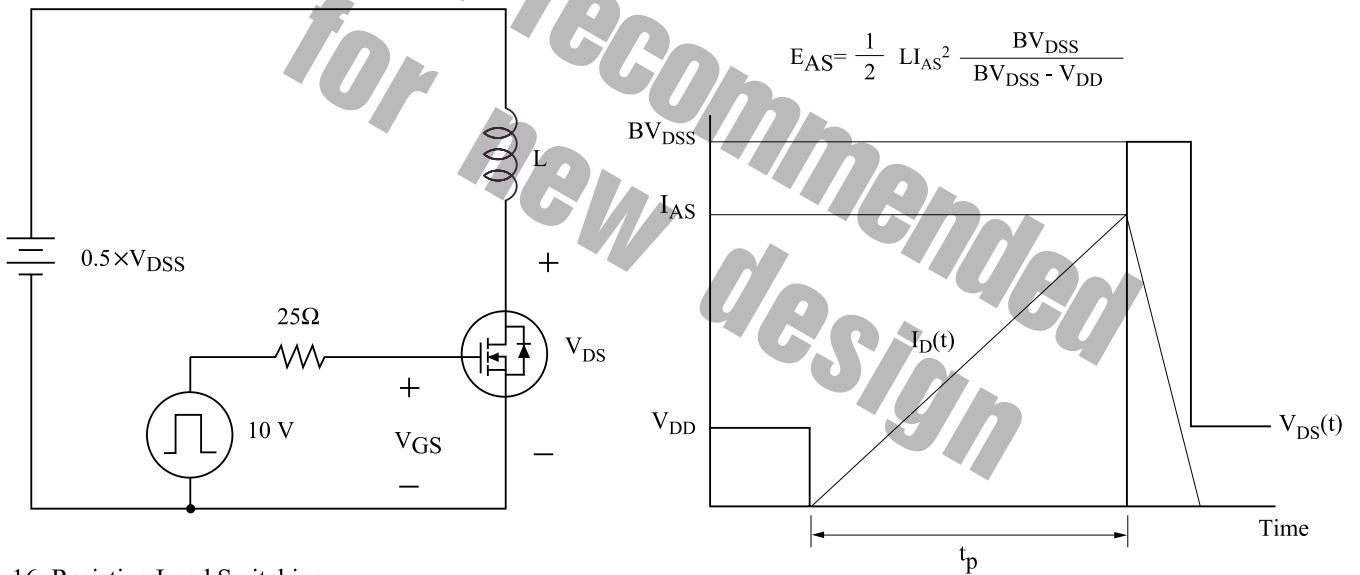


Fig16. Resistive Load Switching

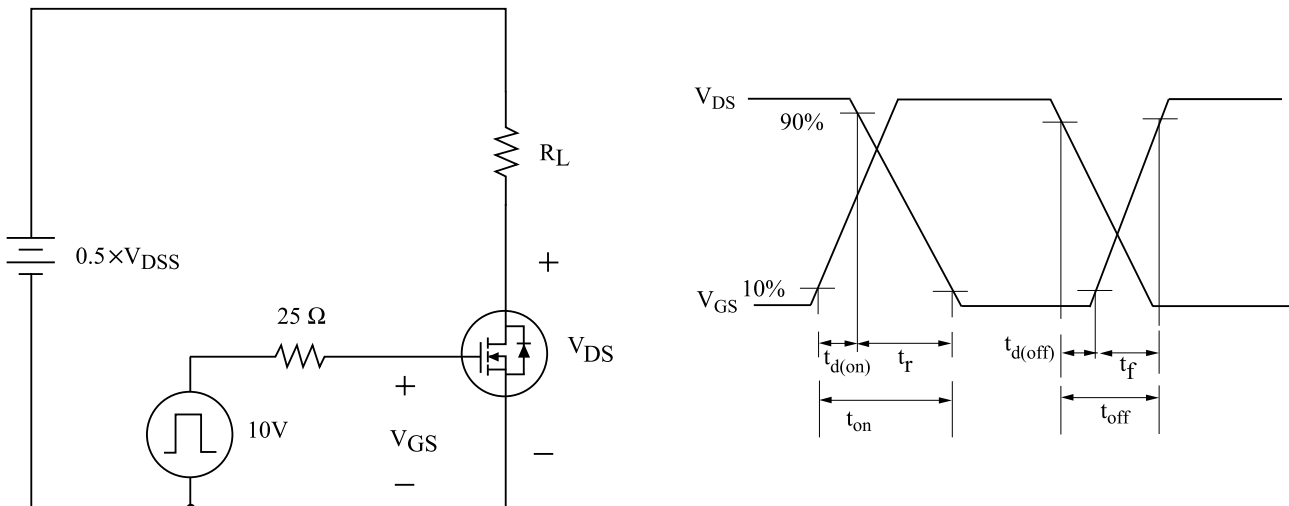
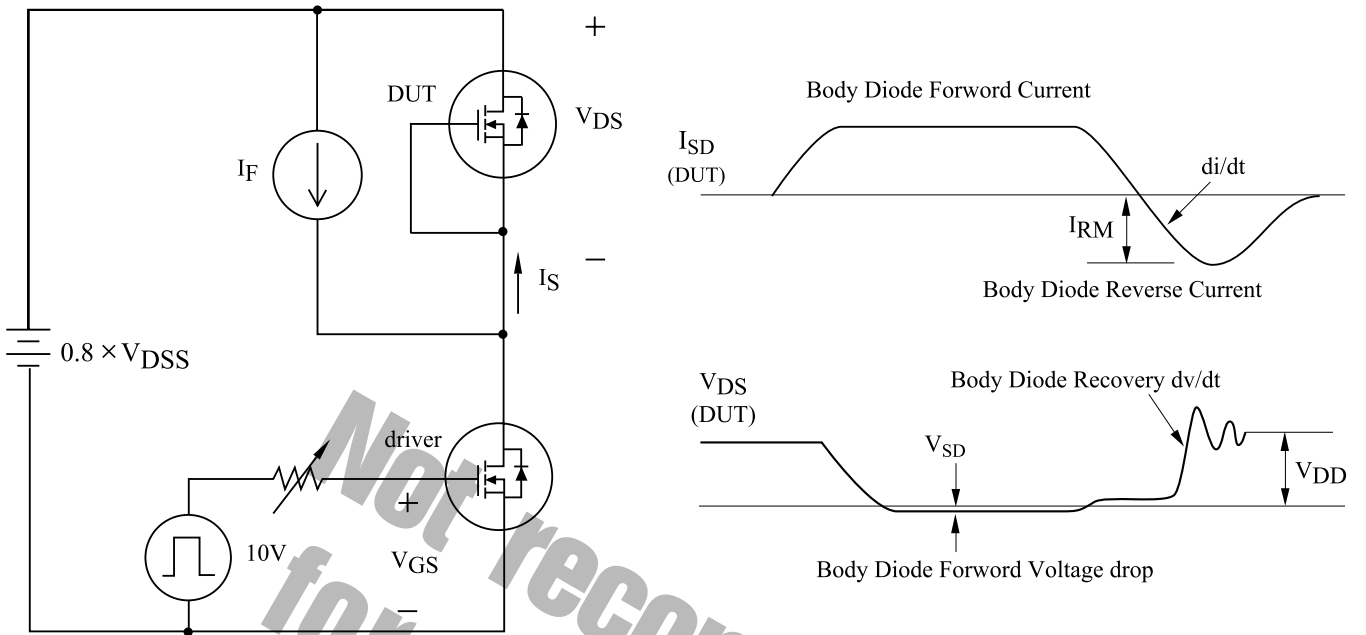


Fig17. Source - Drain Diode Reverse Recovery and  $dv/dt$



Not recommended for new design